Electronic Patent Application Fee Transmittal						
Application Number:	10568755					
Filing Date:	21-Feb-2006					
Title of Invention:		Microsystem component and method for gluing microcomponents to a substrate				
First Named Inventor/Applicant Name:	Stefan Boehm					
Filer:	Michael E. Whitham					
Attorney Docket Number:	03100282AA					
Filed as Large Entity						
U.S. National Stage under 35 USC 371 Filing	Fee	s				
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)	
Basic Filing:						
Pages:						
Claims:						
Miscellaneous-Filing:						
Petition:						
Patent-Appeals-and-Interference:						
Post-Allowance-and-Post-Issuance:						
Extension-of-Time:						
Extension - 1 month with \$0 paid		1251	1	130	130	

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)				
Miscellaneous:								
Request for continued examination	1801	1	810	810				
	Tot	940						